MAR 1 4 2005

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Ichio YUDASAKA, Tatsuya SHIMODA, Sadao KANBE and Wakao MIYAZAWA

Application No.: 09/901,126

Filed: July 1

July 10, 2001

Docket No.:

040090.02

For:

THIN FILM DEVICE PROVIDED WITH COATING FILM, LIQUID CRYSTAL

PANEL AND ELECTRONIC DEVICE, AND METHOD FOR MAKING THE THIN

FILM DEVICE

REQUEST FOR DECLARATION OF INTERFERENCE

Director of the U.S. Patent and Trademark Office Washington, D. C. 20231

Sir:

Applicants hereby respectfully request that an Interference be declared between the above-identified patent application and United States Patent No. 6,087,196 to Sturm et al. (hereinafter "Sturm"), attached to the Information Disclosure Statement filed on July 10, 2001.

Specifically, the Applicants request that an Interference be declared between claims 82, 83, and 111-113 of the present Application and claims 23-29 of Sturm.

Additionally, the Applicants propose that count 3 set forth in Appendices A and B, be made the count of the Interference. The count is numbered 3 to avoid confusion with other counts (numbered differently) of Interferences in Applicants' other Applications, in which corresponding Requests for Declaration of Interference and a Petition for Consolidation of Three Interferences are being concurrently filed.¹

¹ United States Patent Applications with Serial Numbers 09/901,097 and 09/901,095 are the other Applications in which concurrent Requests for Declaration of Interference are being filed.

Moreover, the Applicants respectfully request that claims 82, 83, and 111-113 of the present Application and claims 23-29 of Sturm be designated as corresponding to count 3.

The Applicants note that claim 111 of the present Application corresponds exactly to count 3. Claim 23 of Sturm and claim 82 of the present Application are identical and both would have been obvious over count 3 (and count 3 is anticipated by them). Additionally, claim 23 of Sturm broadly recites the semiconducting polymer layer and has a scope encompassed by claim 112 of the present Application.

Claim 24 of Sturm and claim 83 of the present Application are identical and may suffer from 35 U.S.C. §112, second and fourth paragraph, problems, correcting which problems may yield claim 113 of the present Application.

Claims 25-29 of Sturm recite further features that would have been obvious over claim 23 of Sturm, which would make them obvious over count 3 and over claim 82 of this Application.

Attached Appendix A shows the support for features of claims 82, 83, and 111-113 in the present Application. Attached Appendix A also shows the support in Japanese Priority Document, JP 8-120653, filed in Japan on May 15, 1996, for proposed features recited in interference count 3. Attached Appendix B lays out the rationale for correspondence between count 3, claims 82, 83, and 111-113 of the present Application, and claims 23-29 of Sturm.

Furthermore, the Applicants respectfully request that the Examiner acknowledge in the Declaration of Interference Applicants' right to the benefit of PCT/JP 97/01618, filed May 14, 1997. Additionally, the Applicants respectfully request that the Examiner acknowledge in the Declaration of Interference Applicants' right to the benefit of their Japanese Priority Document, JP 8-120653, filed in Japan on May 15, 1996.

Applicants respectfully submit that all of the claims pending in this Application meet the requirements of 35 U.S.C. §135(b), and therefore satisfy 37 C.F.R. §1.607(a)(6), because

Application No. 09/901,126

the preliminary amendment filed on July 10, 2001 (less than one year after issue date of Sturm) presented claims to the same subject matter as claims added after July 11, 2001.

In accordance with 37 C.F.R. §1.607(b), the Applicants respectfully request that examination of the present Application be conducted with special dispatch within the Patent and Trademark Office. Attention is respectfully directed to the Petition for Consolidation of Three Interferences, a copy of which is attached.

Should there be any questions concerning this communication, please telephone the undersigned at the number set forth below.

Respectfully submitted,

James A. Oliff Registration No. 27,075

Hrayr A. Sayadian Registration No. 46,491

JAO:HAS/tbh

Attachments:

Appendix A Appendix B Petition

Date: February 27, 2002

OLIFF & BERRIDGE, PLC P.O. Box 19928 Alexandria, Virginia 22320 Telephone: (703) 836-6400 DEPOSIT ACCOUNT USE
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		-	301 100/00 -: - 0	Support in Priority Doc. JP 8-120653
Count	Claim in '196 Patent	Claims in 09/901,126	Support in 09/901,120	- Control of the cont
3	24. The process of claim 23	83. The process of claim 82	P94, L22-P95, L4; Figs. 14-16; and	
	wherein said gate insulator is	wherein said gate insulator is	P56, L1-P59, L2.	
	formed by ink-jet printing, and	formed by ink-jet printing, and		
	the semiconducting layer by	the semiconducting layer by		
	other techniques.	other techniques.		Por 642 through none 26 644 describes
Count 3. A process of forming		111. A process of forming thin	Fig. 38(B), P93, L1-4:	the TFT and its components (by
thin film field effect transistors		film field effect transistors	reverse stagger-type 1 r 1.	reference to Figures 3 and 4, including
comprising the steps of:		comprising the steps of:	Fig. 36(B), F93, E1-174, E21.	an insulating substrate 401, a gate
forming a gate electrode on		torming a gate electrode on	anstactive underlayer 411	electrode 405, gate insulating film 404,
a substrate;		a substrate;	aste electrode 415.	semiconducting channel region 403,
forming a gate insulator		Johnson age electrode	gate insulating film 413.	source contacts 403S, and drain contacts
over said gate electrode;		forming a semiconducting	- amorphous silicon film 417.	403D), wherein the channel region is a
forming a semiconducting		layer on said insulator by ink-jet	- source/drain electrodes 431, 492.	semiconductor formed from polymer
layer on said insulator by ink-jet		nrinting: and	P94, L22, P95, L4:	silane having various plural monomer
printing; and		forming source and drain	semiconducting layer can be	units as the material forming the
forming source and drain		contacts on said semiconducting	formed of a coating film as in the	semiconducting layer;
contacts on said semiconducting		lover	first embodiment.	P39, 439 describes using ink-jetting to
layer.		19701.	Figs. 14-16; P56, L1-P59, L21:	form the channel and the insulating film.
			Ink-jet printing also, applicable to the	
			silicon film forming the channel	
			region (region 14C between 14S and	
			14D in Fig. 10). See P58, L5-9.	
	-			

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Current in Drivrity Dac IP 8-120653	Support in the first of the same		
201 100100	Support in 09/901,120	P41.42: using silane having various plural monomer units as the material forming the conductive layer; P58, L5-9: using ink-jetting to deposit the material forming the conductive layer.	P94, L22-P95, L4; Figs. 14-16; and P56, L1-P59, L2.
	Claims in 09/901,126	112. The process of claim 111 wherein said formed semiconducting layer has a molecular structure containing plural monomer units.	113. The process of claim 82 wherein said gate insulator is formed by ink-jet printing.
	Claim in '196 Patent		
	Count	3	3

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Rationale for Correspondence Between the Claims and the Count	Count 3 does not recite forming a polymer semiconducting layer on said insulator by ink-jet printing. However, it would have been obvious to replace the semiconducting layer by a polymer semiconducting layer to achieve stable and low voltage transistor operation in an inexpensive manner. See, e.g., Ebisawa (1983), and Japanese Unexamined Publication Nos. (JP-A) 62-311174 and 62-85224. See, also the abstract in Aratani '139 disclosing using organic thin films instead of semiconductors to achieve a stable, long life, and low voltage devices. Additionally, features of count 3 are anticipated by features of claim 23 of the '196 patent and claim	82 of this Application.
Rationale for Correspondence Between Claims of '196 Patent and the Claims in	Claim 82 of this Application is a copy of claim 23 of the '196 patent Claim 82 of this Application does not explicitly disclose forming a polymer semiconducting layer on said insulator by ink-jet printing. However, it would have been obvious to use a polymer semiconducting layer as the semiconducting layer to achieve stable and low voltage transistor operation. See, e.g., the abstract in Aratani '139 disclosing using organic thin film semiconductors to achieve a stable, long life, and low voltage devices.	Additionally, features of claim 82 of this Application are anticipated by features of claim 23 of the '196 patent.
Correspon d to count	E C	
Claims in 09/901,126	82. A process of forming thin film field effect transistors comprising the steps of: forming a gate electrode on a substrate; forming a gate insulator over said gate electrode; forming a polymer semiconducting layer on said insulator by ink-jet printing; and forming source and drain contacts on said semiconducting layer.	
Claims in '196 Patent	23. A process of forming thin film field effect transistors comprising the steps of: forming a gate electrode on a substrate; forming a gate insulator over said gate electrode; forming a polymer semiconducting layer on said insulator by ink-jet printing; and forming source and drain contacts on said semiconducting layer.	

		obvious to form the gate insulator using ink-jet printing. See, e.g., Drummon '248 disclosing ink-	jet depositing various materials including	insulators because the depositing by the link-jet method is less expensive and simple, see, e.g.,	column 4, lines 40-55. Additionally, it would have	semiconducting layer is formed above the gate	insulator and it would simplify the processing to	Moreover, it would have been obvious to replace	the semiconducting layer by a polymer	semiconducting layer to achieve stable and row voltage transistor operation in an inexpensive	manner. See, e.g., Ebisawa (1983), and Japanese	Unexamined Publication Nos. (JrA) 02-311174 and 62-85224. See, also the abstract in Aratani	'139 disclosing using organic thin films instead of	semiconductors to achieve a stable, long life, and low voltage devices.	Additionally, features of count 3 are anticipated by features of claim 24 of the '196 patent and claim 83 of this Amilication
Rationale for Correspondence Between Claims of 196 Patent and the Claims in 09/901,126	Claim 83 of this Application is a copy of claim 24 of the '196 patent														
Correspon d to count No.	٣					_									
Claims in 09/901,126	83. The process of claim 82 wherein said gate insulator is	formed by ink-jet printing, and	other techniques.		. •										
Claims in '196 Patent	24. The process of claim 23 wherein said gate insulator is	formed by ink-jet printing, and	other techniques.	·											

Rationale for Correspondence Between the Claims and the Count	Claim 111 of this Application is a copy of Count 3.	
Rationale for Correspondence Between Claims of '196 Patent and the Claims in	does not explicitly niconducting layer nating. However, it place the ymer we stable and low an inexpensive 1983), and tion Nos. (JP-A) is, also the abstract g organic thin its to achieve a ge devices.	Additionally, features of claim 111 of this Application are anticipated by features of claim 23 of the '196 patent.
Correspon d to count	<u>.</u>	
Claims in 09/901,126	film field effect transistors comprising the steps of: forming a gate electrode on a substrate; forming a gate insulator over said gate electrode; forming a semiconducting layer on said insulator by ink-jet printing; and forming source and drain contacts on said semiconducting layer.	
Claims in '196 Patent	23. A process of forming thin film field effect transistors comprising the steps of: forming a gate electrode on a substrate; forming a gate insulator over said gate electrode; forming a polymer semiconducting layer on said insulator by ink-jet printing; and forming source and drain contacts on said semiconducting layer.	

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Rationale for Correspondence Between the Claims and the Count	Count 3 does not recite forming a semiconducting layer on said insulator by ink-jet printing, wherein said formed semiconducting layer has a molecular structure containing a polymer consisting of plural monomer units. However, it would have been obvious to replace the semiconducting layer has a molecular structure containing a polymer consisting of plural monomer units to achieve stable and low voltage transistor operation in an inexpensive manner. See, e.g., Ebisawa (1983), and Japanese Unexamined Publication Nos. (JP-A) 62-311174 and 62-85224. See, also the abstract in Aratani '139 disclosing using organic thin films instead of semiconductors to achieve a stable, long life, and low voltage devices.	Additionally, features of count 3 are anticipated by features of claim 23 of the '196 patent and claim 112 of this Application.
Rationale for Correspondence Between Claims of '196 Patent and the Claims in 09/901,126	The broad recitation of polymer in claim 23 of the '196 patent makes claim 112 of this Application anticipate claim 23 of the '196 patent, and vise-versa.	
Correspon d to count No.	m	· .
Claims in 09/901,126	wherein said formed semiconducting layer has a molecular structure containing plural monomer units.	
Claims in '196 Patent		

Kationale for Coll espondence Servers	Count 3 does not recite forming the gate insulator by ink-jet printing. However, it would have been	printing. See, e.g., Drummon '248 disclosing inkiet denositing various materials including	insulators because the depositing by the ink-jet method is less expensive and simple, see, e.g.,	column 4, lines 40-55. Additionally, it would have	semiconducting layer is formed above the gate	insulator and it would simplify the processing to	use ink-jet printing to form bour elements. Moreover, it would have been obvious to replace	the semiconducting layer by a polymer semiconducting layer to achieve stable and low	voltage transistor operation in an inexpensive	manner. See, e.g., Edisawa (1705), and Japanese Unexamined Publication Nos. (JP-A) 62-311174	and 62-85224. See, also the abstract in Aratani	'139 disclosing using organic thin thins instead of semiconductors to achieve a stable, long life, and	low voltage devices.	Additionally, features of count 3 are anticipated by features of claim 113 of this Application.
Rationale for Correspondence Between Claims of '196 Patent and the Claims in	Claim 24 of the '196 patent may suffer 35 U.S.C. §112, second and fourth paragraphs, problems,	correcting which problem may lead to a claim similar to claim 113 of the present Application.												
Correspon d to count	3													
Claims in 09/901,126	113. The process of claim 82 wherein said gate insulator is	formed by ink-jet printing.												
Claims in '196 Patent														

Claims in '196 Patent	Claims in 09/901,126	Correspon	Rationale for Correspondence Between	Rationale for Correspondence Between the
		d to count	Claims of '196 Patent and the Claims in new 176	Ciaims and the Count
25 The process of claim 23		3	The analysis above with respect to claim 23 of	It is notoriously well known practice in the
wherein the source and drain			the '196 patent is incorporated herein.	semiconductor processing art to perform as much
contacts are applied directly on			Additionally, it is notoriously well known	of the same processing together as possible to
the gate insulator before the			practice in the semiconductor processing art to	economize on wasteful process change
semiconducting layer is			perform as much of the same processing together	preparations. Consequently, it would have been
denosited.			as possible to economize on wasteful process	obvious to apply the source and drain before
			change preparations. Consequently, it would	depositing the semiconducting layer.
			have been obvious to apply the source and drain	
	:		before depositing the semiconducting layer.	Additionally, reatures of count 3 are anticipated by
				features of claim 25 of the 190 patent.
			Additionally, features of claim 82 of this	
			Application are anticipated by features of claim	
			25 of the '196 patent.	
26 The process of claim 24		3	The analysis above with respect to claim 24 of	It is notoriously well known practice in the
wherein the course and drain			the '196 patent is incorporated herein.	semiconductor processing art to perform as much
Wilefelli tile source and diagram			Additionally, it is notoriously well known	of the same processing together as possible to
contacts are applied unectry on			practice in the semiconductor processing art to	economize on wasteful process change
the gate insulator belofe inc			perform as much of the same processing together	preparations. Consequently, it would have been
Semiconducting layer is			as possible to economize on wasteful process	obvious to apply the source and drain before
deposited.			change preparations. Consequently, it would	depositing the semiconducting layer.
			have been obvious to apply the source and drain	
			before depositing the semiconducting layer.	Additionally, features of count 3 are anticipated by features of claim 26 of the '196 patent.
			Additionally, features of claim 83 of this	
			Application are anticipated by features of claim	
			26 of the '196 patent.	

Rationale for Correspondence Between the Claims and the Count	Count 3 does not recite mixing a polymer with other organic molecules. However, it is well known to use a blend of polymer with other organic molecules including dyes with small molecular structure, instead of separate layers, to use a single deposition step and thus simplify the deposition process. See, e.g., Mori '489, column 3 lines 22-46 and Example 1 in column 30 lines 54-63, disclosing the use of blend of a polymer and a small organic molecule; see also, e.g., Vestweber (1994), the second paragraph in section titled Introduction on p. 141. Additionally, features of count 3 are anticipated by features claim 27 of the '196 patent.
Rationale for Correspondence Between Claims of '196 Patent and the Claims in	The analysis above with respect to claim 23 of the '196 patent is incorporated herein. Additionally, claim 82 of this Application does not explicitly disclose mixing a polymer with other organic molecules. However, it is well known to use a blend of polymer with other organic molecules including dyes with small molecular structure, instead of separate layers, to use a single deposition step and thus simplify the deposition process and produce electroluminescence efficiency and brightness even at luminescence efficiency and brightness even at low voltage and low current density. See, e.g., Mori '489, col. 2, line 66, to col. 3, line 46 and Example 1 in column 30 lines 54-63, disclosing the use of blend of a polymer and a small organic molecule; see also, e.g., Vestweber (1994), the second paragraph in section titled Introduction on p. 141, stating that polymer blends consisting of a mixture of a charge transport component and a polymeric binder offers the advantage of combining easy spectral tuning by appropriate selection of the active component with the processibility and good mechanical properties of molecules. Additionally, features of claim 82 of this Application are anticipated by features of claim 27 of the '106 patent
Correspon d to count	
Claims in 09/901,126	
Claims in '196 Patent	wherein the semiconducting wherein the semiconducting layer comprises a nonpolymeric organic film or a polymer/small organic molecule blend.

Claims in '196 Patent	Claims in 09/901,126	Correspon	Rationale for Correspondence Between	Rationale for Correspondence Between the
		d to count	Claims of '196 Patent and the Claims in	Claims and the Count
		Zo.	09/901,126	
28 The process of claim 24		3	The analysis above with respect to claim 24 of	Count 3 does not recite mixing a polymer with
wherein the semiconducting			the '196 patent is incorporated herein.	other organic molecules. However, it is well
laver comprises a non-			Additionally, claim 83 of this Application does	known to use a blend of polymer with other
nolymeric organic film or a			not explicitly disclose mixing a polymer with	organic molecules including dyes with small
polyment organic molecule			other organic molecules. However, it is well	molecular structure, instead of separate layers, to
bland			known to use a blend of polymer with other	use a single deposition step and thus simplify the
Oldina:			organic molecules including dyes with small	deposition process. See, e.g., Mori '489, column 3
÷			molecular structure, instead of separate layers, to	lines 22-46 and Example 1 in column 30 lines 54-
			use a single deposition step and thus simplify the	63, disclosing the use of blend of a polymer and a
			deposition process. See, e.g., Mori '489, column	small organic molecule; see also, e.g., Vestweber
			3 lines 22-46 and Example 1 in column 30 lines	(1994), the second paragraph in section titled
		_	54-63, disclosing the use of blend of a polymer	Introduction on p. 141.
			and a small organic molecule; see also, e.g.,	•
			Vestweber (1994), the second paragraph in	Additionally, features of count 3 are anticipated by
			section titled Introduction on p. 141.	features of claim 28 of the '196 patent.
	•			
			Additionally, features of claim 83 of this	
			Application are anticipated by features of claim	
			28 of the '196 patent.	

Claims in '196 Patent				
	Claims in 09/901,120	Correspon d to count	Claims of '196 Patent and the Claims in	Claims and the Count
		Ž.	09/901,126	thin raminion o coining this
30		3	The analysis above with respect to claim 25 of	Count 3 does not recite mixing a polymer with
29. The process of claim 25		1	the '196 natent is incorporated herein.	other organic molecules. However, it is well
wherein the semiconducting			Additionally, claim 82 of this Application does	known to use a blend of polymer with other
layer comprises a non-			and surficiely, disclose mixing a polymer with	organic molecules including dyes with small
nolymeric organic film or a			not explicitly discussed from the performance of the month.	molecular structure, instead of separate layers, to
polymer/small organic molecule			other organic molecules. However, it is wen	single deposition sten and thus simplify the
polymen siman organic morcone			known to use a blend of polymer with other	use a single deposition step mis time 3 1
blend.			organic molecules including dyes with small	deposition process. See, e.g., ivioir 40%, commission
			molecular structure, instead of separate layers, to	lines 22-46 and Example 1 in column 30 inics 34
			in a simple deposition step and thus simplify the	63, disclosing the use of blend of a polymer and a
			use a single deposition step and the second and the	small organic molecule; see also, e.g., Vestweber
			deposition process. See, e.g., Moli 107, Column	(1004) the second naragraph in section titled
			3 lines 22-46 and Example 1 in column 30 lines	(1774), inc second per en-
			44-63 disclosing the use of blend of a polymer	Introduction on p. 141.
			1	
			and a sinall organic morecus; see each :	Additionally features of count 3 are anticipated by
			Vestweber (1994), the second paragraph in	Continuity, contract 106 natent
			section titled Introduction on p. 141.	reatures of claim 27 of the 170 parents
·,			A 14:4:4:4: features of claim 82 of this	
			Additionally, teatures of ciams of con-	
			Application are anticipated by reatures of claim	
			29 of the '196 natent.	

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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Satoru MIYASHITA, Hiroshi KIGUCHI, Tatsuya SHIMODA and Sadao KANBE

Application No.: 09/901,097

Filed: July 10, 2001

Docket No.: 101050.02

For: METHOD OF MANUFACTURING ORGANIC EL ELEMENT, ORGANIC EL ELEMENT, AND ORGANIC EL DISPLAY DEVICE

PETITION FOR CONSOLIDATION OF THREE INTERFERENCES

Director of the U.S. Patent and Trademark Office Washington, D. C. 20231

Sir:

This is a petition under 37 C.F.R. §1.182 requesting that three requested interference proceedings be consolidated. Specifically, this Petition requests the consolidation of the interferences resulting from three Requests for Declaration of Interference, concurrently filed in the above-identified Application and co-pending United States Patent Applications having Serial Numbers 09/901,095 and 09/901,126, seeking the declaration of interference between the above mentioned three applications and United States Patent No. 6,087,196 to Sturm et al. (hereinafter "Sturm").

The Applicants respectfully submit that considerations of efficiency, uniformity, expense, and speed in prosecuting the interferences between the above-identified Applications and Sturm can best be satisfied by consolidating the three Requests for Declaration of Interference and collectively and concurrently prosecuting a single interference between Sturm and the above-identified Applications. See the preamble of 37 C.F.R. §1.601 defining a primary

good of the rules as being to secure the just, speedy, and inexpensive determination of every interference.

In each of the above-referenced Applications, a Request for Declaration of Interference with Sturm is filed.

Additionally, the above-referenced Applications and Sturm are directed to similar subject matter. Broadly speaking, the three Applications and Sturm disclose using ink-jet printing to form semiconducting devices including organic semiconducting elements or including polymeric elements. Indeed, Applications with Serial Numbers 09/901,097 and 09/901,095 include claims exactly, and claims substantially, corresponding to each of interference counts 1 and 2 with corresponding claims of Sturm.

Moreover, the above-identified Applications are assigned to a common assignee.

Accordingly, disputed issues between the three Applications and Sturm address similar subject matter between the same two parties.

Therefore, to efficiently, uniformly, and speedily prosecute the Interference between the above-identified Applications and Sturm, the Applicants respectfully request:

- (1) That the three Requests for Declaration of Interference be consolidated, and
- (2) That the resulting interference proceedings between Sturm and the above-referenced three Applications be consolidated.

Application No. 09/901,097

Attached is our check no. 128238, in the amount of \$130.00, as the petition fee set forth in 37 C.F.R. §1.17(h). If any additional fees are necessary, the U.S. Patent and Trademark Office is authorized to debit Deposit Account No. 15-0461.

Respectfully submitted,

James A. Oliff Registration No. 27,075

Hrayr A. Sayadian Registration No. 46,491

JAO:HAS/tbh

Date: February 27, 2002

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The following papers have been filed:

Third Information Disclosure Statement w/1449, 35 references, 2 English-language abstracts.

Name of Applicant: Ichio YUDASAKA et al.

Serial No.: 09/901,126

Atty. File No.: 040090.02

Title (New Cases): THIN FILM DEVICE PROVIDED WITH COATING FILM, LIQUID

CRYSTAL PANEL AND ELECTRONIC DEVICE, AND METHOD

FOR MAKING THE THIN FILM DEVICE

Sender's Initials: JAO:EDM/gam

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